

MAPX	MODIFICATION	DATE
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Note:

1.Material:

- 1.1,Housing: High temperature thermoplastic with/black g.f,UL94v-0
- 1.2,Contact: copper alloy,t=0.25mm
- 1.3,Shell: copper/Ferroalloy alloy,t=0.30mm

2.Specification:

- 2.1,Current rating:1.5A Max.
- 2.2,Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3,Contact resistance: 30 mΩ Max.
- 2.4,Insulation resistance: 100 MΩ Min.
- 2.5,Total mating force: 3.57 Kgf Max.
- 2.6,Total unmating force: 1.0 Kgf Min.

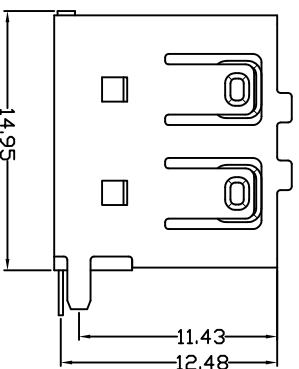
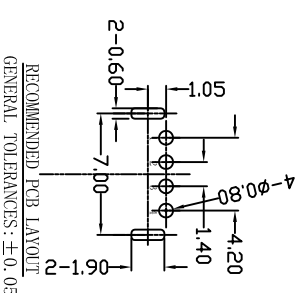
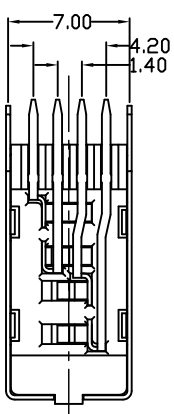
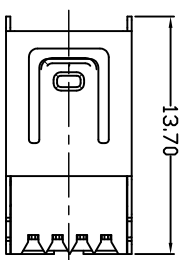
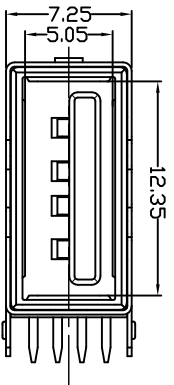
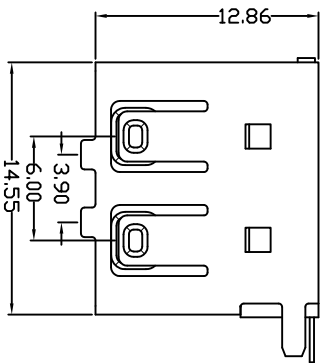
3.Plating:

- 3.1,Terminal: Au Plating on Contact Area
Sn Plating on Solder Area
Nickel Under plating All Over

Shell: Nickel Plating

4.Environmental:

- 4.1,Temperature range: -55°C~85°C



产品图
公差一览表

深圳市精拓金电子有限公司

公差一览表		单位		制图		制图料号	
TOLERANCE UNLESS OTHERWISE		UNITS	MM	DRAWING	Gavin	PRODUCT PART NO	
X	±0.35	X		审核	郭治富	产品名称	USB AF 90 度侧插全包型
X	±0.30	X	1:1	CKD	黄国荣	PRODUCT NO	
.XX	±0.20	.XX		核准		角法	
.XXX	±0.10	.XXX		APPD		版本	AD
			2016-06-13	日期		角法	
				DATE		VER	